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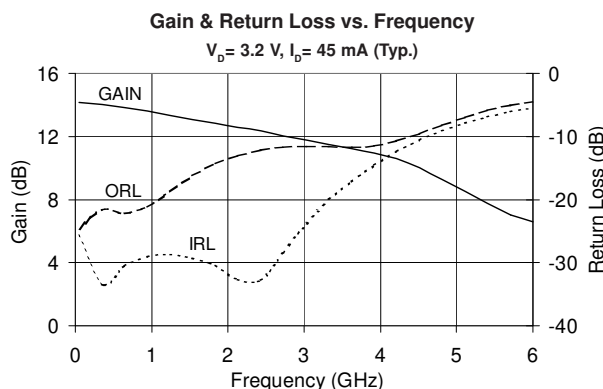


Product Description

The SGA-4263 is a high performance SiGe HBT MMIC Amplifier. A Darlington configuration featuring one-micron emitters provides high F_T and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. Only two DC-blocking capacitors, a bias resistor, and an optional RF choke are required for operation.

Optimum Technology Matching® Applied

- ☐ GaAs HBT
- ☐ GaAs MESFET
- ☐ InGaP HBT
- ☐ SiGe BiCMOS
- ☐ Si BiCMOS
- ☒ SiGe HBT
- ☐ GaAs pHEMT
- ☐ Si CMOS
- ☐ Si BJT
- ☐ GaN HEMT
- ☐ RF MEMS



Features

- Available in Lead Free, RoHS Compliant, and Green Packaging (Z Part Number)
- Broadband Operation: DC to 3500MHz
- Cascadable 50 Ω
- Operates from Single Supply
- Low Thermal Resistance Package

Applications

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier
- Wireless Data, Satellite

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Small Signal Gain	12.5	14.0	15.5	dB	850MHz
		12.7		dB	1950MHz
		12.4		dB	2400MHz
Output Power at 1dB Compression		14.2		dBm	850MHz
		12.5		dBm	1950MHz
Output Third Intercept Point		29.3		dBm	850MHz
		25.7		dBm	1950MHz
Bandwidth Determined by Return Loss		3500		MHz	>10dB
Input Return Loss		31.3		dB	1950MHz
Output Return Loss		13.8		dB	1950MHz
Noise Figure		3.7		dB	1950MHz
Device Operating Voltage	2.9	3.2	3.5	V	
Device Operating Current	41	45	49	mA	
Thermal Resistance (Junction - Lead)		255		$^{\circ}\text{C/W}$	

Test Conditions: $V_S = 8\text{ V}$, $I_D = 45\text{ mA Typ.}$, OIP₃ Tone Spacing = 1MHz, P_{OUT} per tone = -5dBm, R_{BIAS} = 110 Ω , T_L = 25 $^{\circ}\text{C}$, Z_S = Z_L = 50 Ω

Absolute Maximum Ratings

Parameter	Rating	Unit
Max Device Current (I_D)	90	mA
Max Device Voltage (V_D)	5	V
Max RF Input Power	+18	dBm
Max Junction Temp (T_J)	+150	°C
Operating Temp Range (T_L)	-40 to +85	°C
Max Storage Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

Bias Conditions should also satisfy the following expression:

$$I_D V_D < (T_J - T_L) / R_{TH, j-l}$$



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

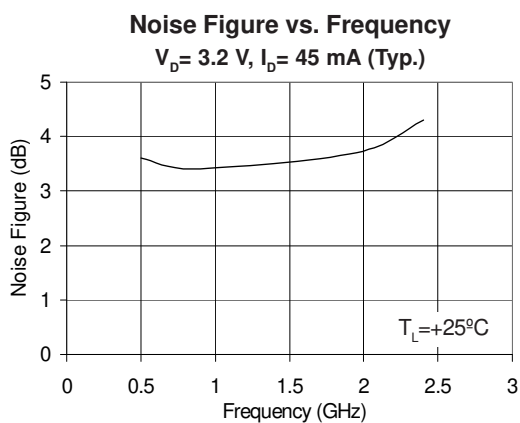
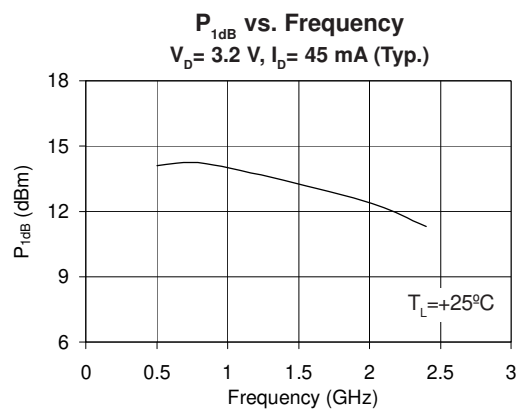
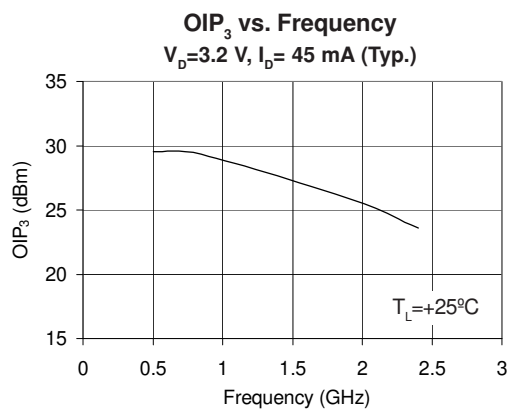
RoHS status based on EUDirective2002/95/EC (at time of this document revision).

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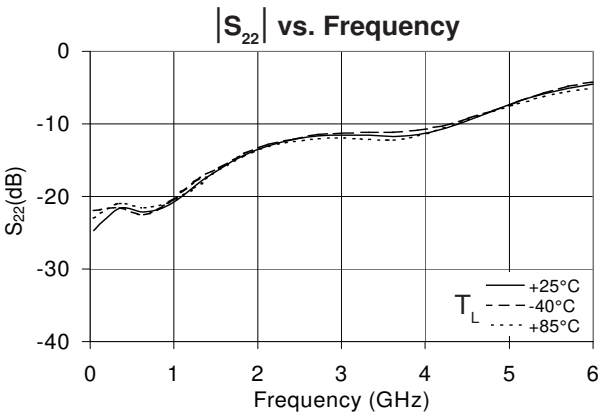
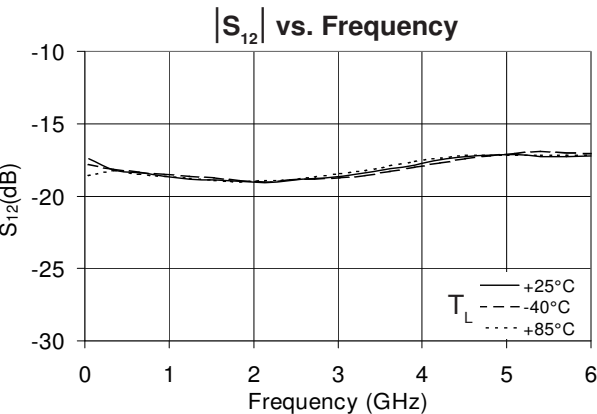
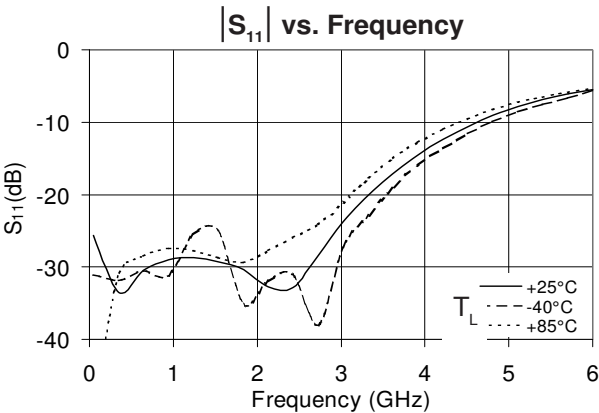
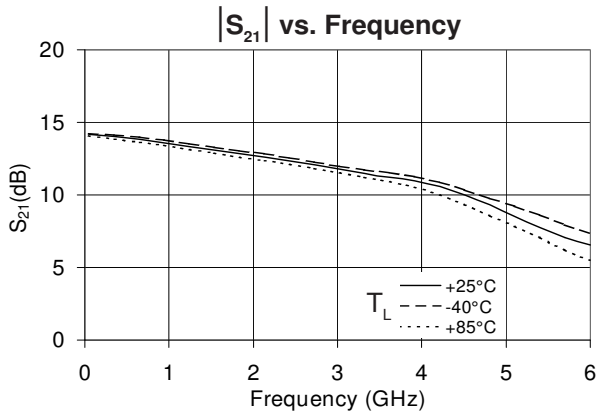
Typical Performance with 2.45GHz Application Circuit

Parameter	Unit	100 MHz	500 MHz	850 MHz	1950 MHz	2400 MHz	3500 MHz
Small Signal Gain	dB	14.1	13.9	14.0	12.7	12.4	11.3
Output Third Order Intercept Point	dBm		29.5	29.3	25.7	23.6	
Output Power at 1dB Compression	dBm		14.1	14.2	12.5	11.3	
Input Return Loss	dB	27.5	31.8	29.4	31.3	33.1	18.3
Output Return Loss	dB	23.4	22.0	21.7	13.8	12.2	11.7
Reverse Isolation	dB	17.7	18.3	18.5	19.0	19.0	18.2
Noise Figure	dB		3.6	3.4	3.7	4.3	

Test Conditions: $V_S = 8V$, $I_D = 45mA$ Typ., OIP₃ Tone Spacing = 1MHz, P_{OUT} per tone = -10dBm, $R_{BIAS} = 100\Omega$, $T_L = 25^\circ C$, $Z_S = Z_L = 50\Omega$

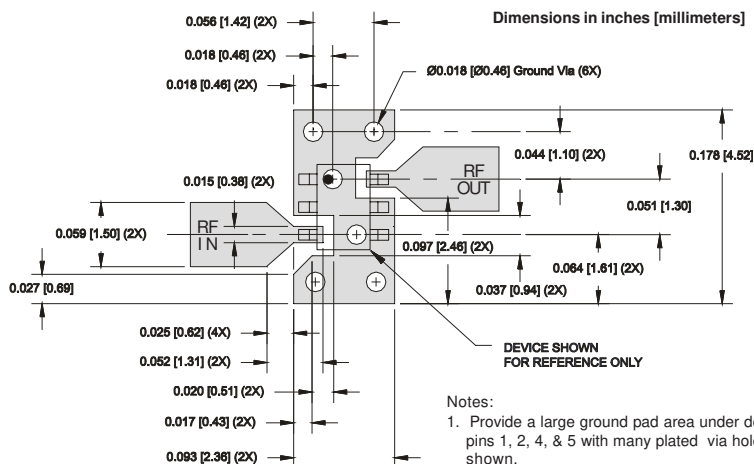


Typical RF Performance Over Temperature (Bias: $V_D = 3.2\text{ V}$, $I_D = 45\text{ mA}$ (Typ.))



Pin	Function	Description
3	RF IN	RF input pin. This pin requires the use of an external DC-blocking capacitor chosen for the frequency of operation.
1, 2, 4, 5	GND	Connection to ground. For optimum RF performance, use via holes as close to ground leads as possible to reduce lead inductance as close to ground leads as possible.
6	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC-blocking capacitor is necessary for proper operation.

Suggested Pad Layout



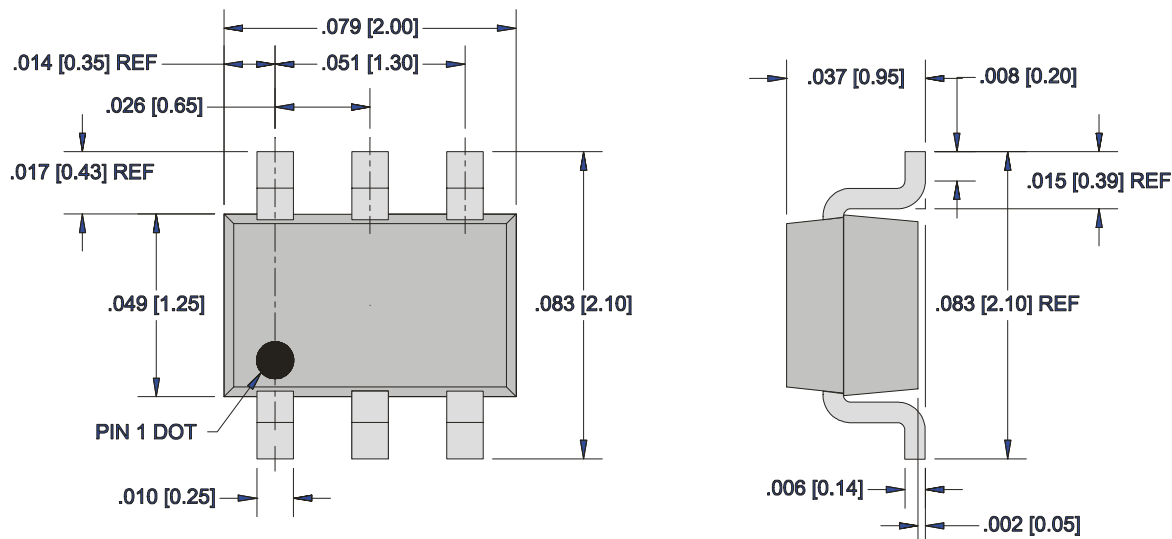
Notes:

1. Provide a large ground pad area under device pins 1, 2, 4, & 5 with many plated via holes as shown.
2. Dimensions given for 50 Ohm RF I/O lines are for 31 mil thick Getek. Scale accordingly for different board thicknesses and dielectric constants.
3. We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick Getek with 1 ounce copper on both sides.

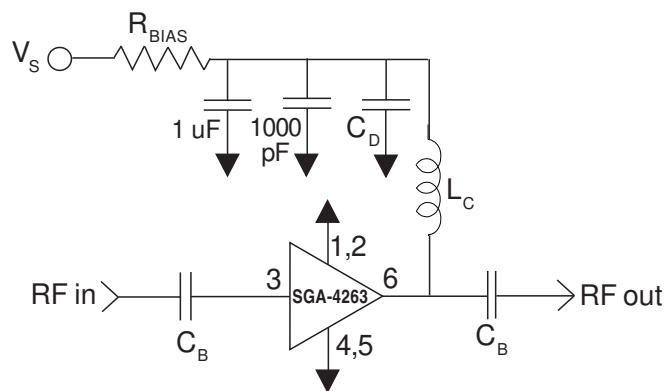
Package Drawing

Dimensions in inches (millimeters)

Refer to drawing posted at www.rfmd.com for tolerances.



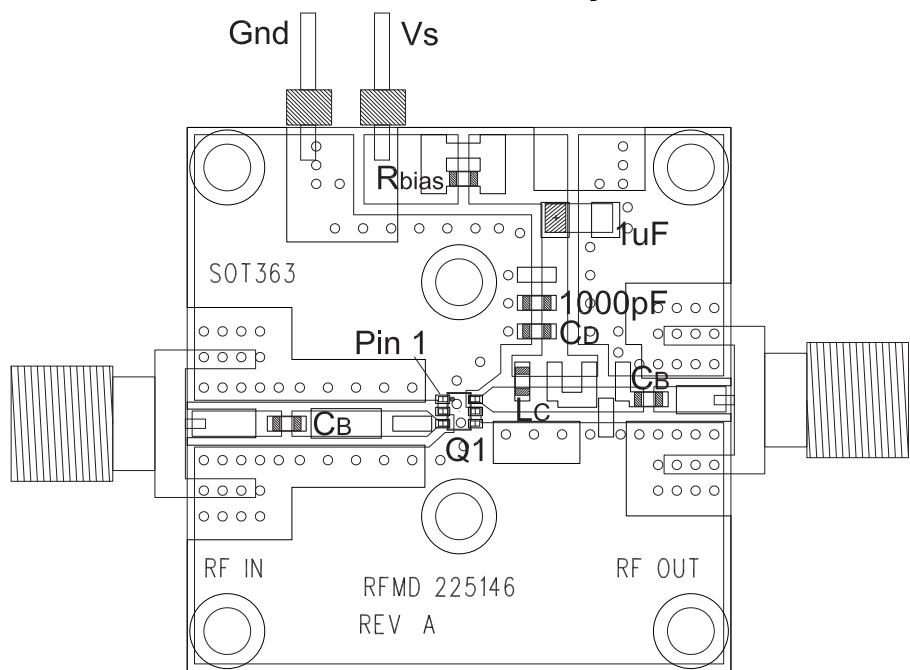
Application Schematic



Reference Designator	Frequency (Mhz)				
	500	850	1950	2400	3500
C _B	220 pF	100 pF	68 pF	56 pF	39 pF
C _D	100 pF	68 pF	22 pF	22 pF	15 pF
L _C	68 nH	33 nH	22 nH	18 nH	15 nH

Recommended Bias Resistor Values for I _D =45mA $R_{BIAS} = (V_s - V_D) / I_D$				
Supply Voltage(V _s)	6 V	8 V	10 V	12 V
R _{BIAS}	62 Ω	110 Ω	150 Ω	200 Ω
Note: R _{BIAS} provides DC bias stability over temperature.				

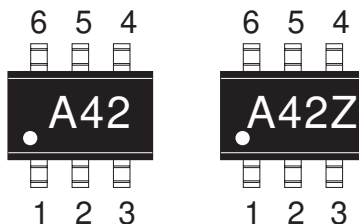
Evaluation Board Layout



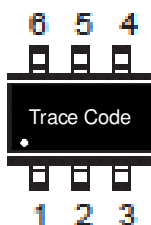
Mounting Instructions:

1. Use a large ground pad area near device pins 1, 2, 4, and 5 with many plated through-holes, as shown.
2. We recommend 1 or 2 ounces copper. Measurements for this data sheet were made on a 31mil thick FR-4 board with 1 ounce copper on both sides.

Part Identification Marking



Alternate Marking with Trace Code Only



Ordering Information

Part Number	Reel Size	Devices/Reel
SGA-4263	7"	3000
SGA-4263Z	7"	3000

